AUTOMOTIVE

RoHS

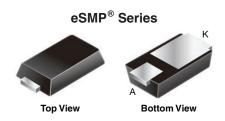
COMPLIANT

HALOGEN



## Vishay General Semiconductor

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



### MicroSMP (DO-219AD)



### **LINKS TO ADDITIONAL RESOURCES**



| PRIMARY CHARACTERISTICS                         |                     |  |  |
|---|---------------------|--|--|
| I <sub>F(AV)</sub>                              | 2 A                 |  |  |
| V <sub>RRM</sub>                                | 100 V               |  |  |
| I <sub>FSM</sub>                                | 30 A                |  |  |
| V <sub>F</sub> at I <sub>F</sub> = 2 A (125 °C) | 0.62 V              |  |  |
| T <sub>J</sub> max.                             | 175 °C              |  |  |
| Package   | MicroSMP (DO-219AD) |  |  |
| Circuit configuration                           | Single              |  |  |

#### **FEATURES**

- Very low profile typical height of 0.65 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- · Low forward voltage drop
- Low power loss, high efficiency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### **TYPICAL APPLICATIONS**

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications, in commercial, industrial, and automotive applications.

#### **MECHANICAL DATA**

Case: MicroSMP (DO-219AD)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, and RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

| MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)                   |  |             |      |  |
|---|--|-------------|------|--|
| PARAMETER   | SYMBOL   | V2PM10      | UNIT |  |
| Device marking code   |  | 2MB         |      |  |
| Maximum repetitive peak reverse voltage   | $V_{RRM}$  | 100         | V    |  |
| Maximum DC forward current  | I <sub>F(AV)</sub> (1)                           | 1.5         | Α    |  |
|   | I <sub>F(AV)</sub> (2)                           | 2           | Α    |  |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I <sub>FSM</sub>                                 | 30          | А    |  |
| Operating junction and storage temperature range                                  | T <sub>J</sub> <sup>(3)</sup> , T <sub>STG</sub> | -40 to +175 | °C   |  |

### Notes

- (1) Free air, mounted on recommended copper pad area
- $^{(2)}$  Mounted on 8.0 mm x 8.0 mm pad area
- $^{(3)}$  The heat generated must be less than the thermal conductivity from junction to ambient:  $dP_D/dT_J < 1/R_{\theta JA}$



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| <b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted) |                        |                         |                               |       |      |      |
|---|------------------------|-------------------------|-------------------------------|-------|------|------|
| PARAMETER   | TEST C                 | TEST CONDITIONS         |                               | TYP.  | MAX. | UNIT |
| Instantaneous forward voltage   | I <sub>F</sub> = 1.0 A | T <sub>A</sub> = 25 °C  |                               | 0.61  | -    | V    |
|   | $I_F = 2.0 \text{ A}$  | T <sub>A</sub> = 25 °C  | V <sub>F</sub> <sup>(1)</sup> | 0.75  | 0.83 |      |
|   | I <sub>F</sub> = 1.0 A | T <sub>A</sub> = 125 °C |                               | 0.53  | -    |      |
|   | I <sub>F</sub> = 2.0 A | T <sub>A</sub> = 125 °C |                               | 0.62  | 0.7  |      |
| Reverse current   | V <sub>R</sub> = 70 V  | T <sub>A</sub> = 25 °C  | I <sub>R</sub> <sup>(2)</sup> | 0.001 | -    | - mA |
|   | V <sub>R</sub> = 70 V  | T <sub>A</sub> = 125 °C |                               | 0.25  | -    |      |
|   | V <sub>R</sub> = 100 V | T <sub>A</sub> = 25 °C  |                               | -     | 0.05 |      |
|   | v <sub>R</sub> = 100 v | T <sub>A</sub> = 125 °C |                               | 0.5   | 2    |      |
| Typical junction capacitance  | 4.0 V, 1 MHz           |                         | CJ                            | 150   | -    | pF   |

#### **Notes**

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: pulse width  $\leq 5$  ms

| THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted) |                          |     |      |  |
|---|--------------------------|-----|------|--|
| PARAMETER   | SYMBOL V2PM10            |     |      |  |
| Typical thermal resistance  | R <sub>0</sub> JA (1)(2) | 130 | °C/W |  |
|   | R <sub>0JM</sub> (3)     | 20  |      |  |

#### **Notes**

- $^{(1)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$
- $^{(2)}$  Free air, mounted on FR4 PCB, 2 oz. standard footprint,  $R_{\theta JA}$  junction to ambient
- Mounted on PCB with 8.0 mm x 8.0 mm copper pad areas,  $R_{\theta JM}$  junction to mount

| ORDERING INFORMATION (Example) |                 |                        |               |                                   |
|--------------------------------|-----------------|------------------------|---------------|-----------------------------------|
| PREFERRED P/N                  | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                     |
| V2PM10-M3/H                    | 0.006           | Н                      | 4500          | 7" diameter plastic tape and reel |
| V2PM10HM3/H (1)                | 0.006           | Н                      | 4500          | 7" diameter plastic tape and reel |

### Note

### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

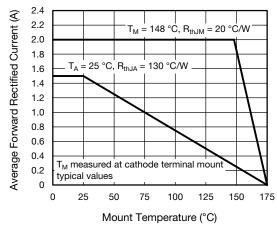


Fig. 1 - Maximum Forward Current Derating Curve

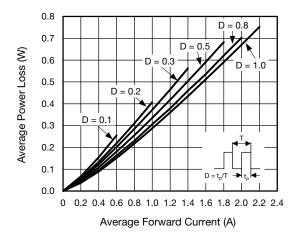


Fig. 2 - Average Power Loss Characteristics

<sup>(1)</sup> AEC-Q101 qualified



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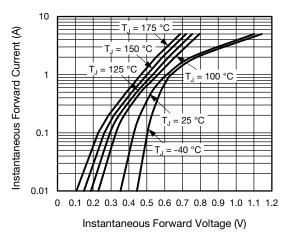


Fig. 3 - Typical Instantaneous Forward Characteristics

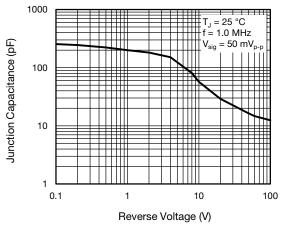


Fig. 5 - Typical Junction Capacitance

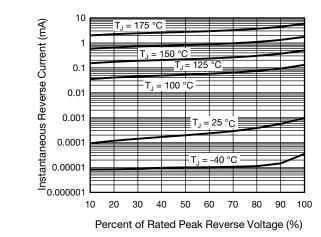


Fig. 4 - Typical Reverse Leakage Characteristics

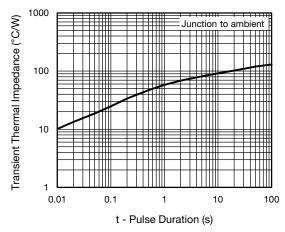
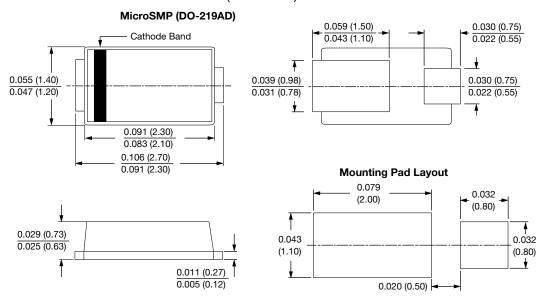


Fig. 6 - Typical Transient Thermal Impedance

### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)



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